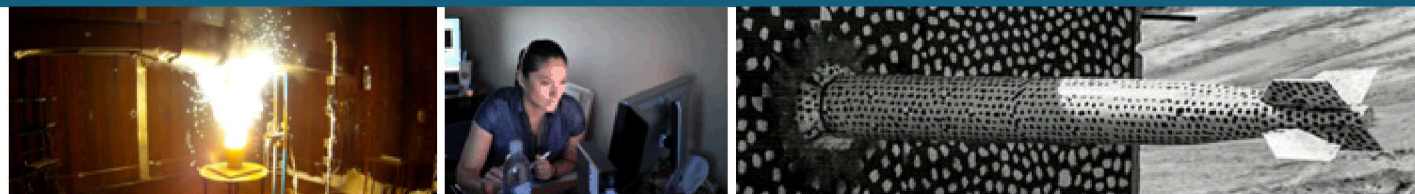


Time Dependence of Pyroelectric Response in $\text{Hf}_{0.58}\text{Zr}_{0.42}\text{O}_2$ Films



PRESENTED BY

Sean W. Smith,¹ M. David Henry,¹ Mark A. Rodriguez,¹ and Jon F. Ihlefeld²

¹Sandia National Laboratories, Albuquerque, New Mexico, USA

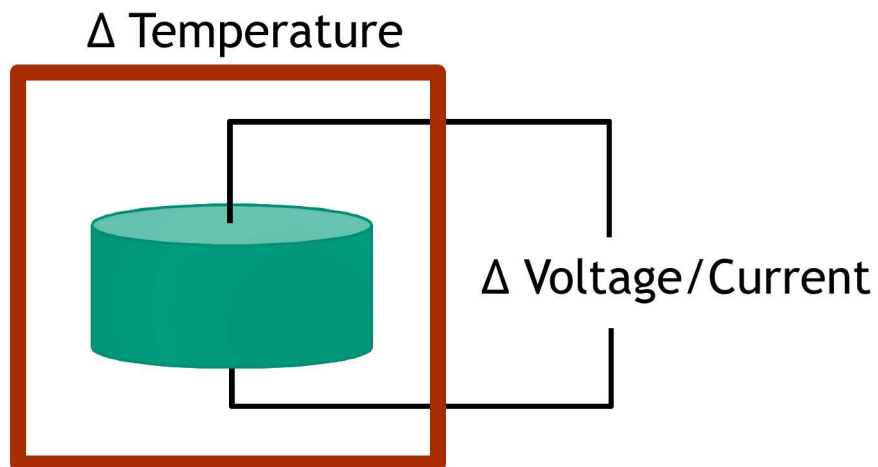
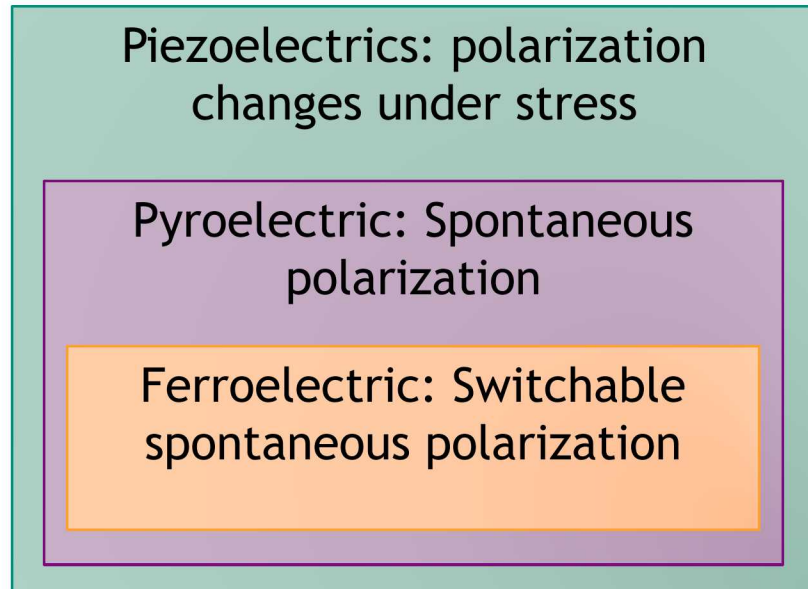
²University of Virginia, Charlottesville, Virginia, USA

ssmith5@sandia.gov

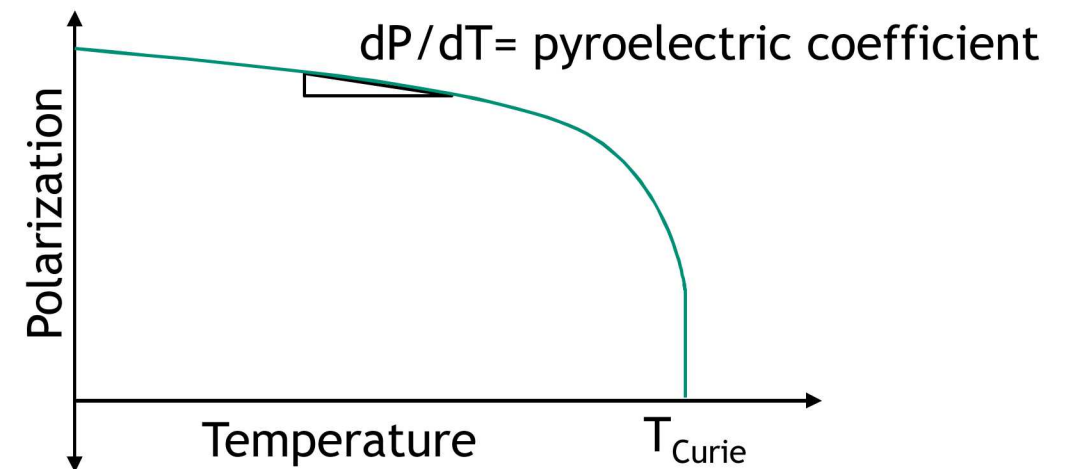


Sandia National Laboratories is a multimission laboratory managed and operated by National Technology and Engineering Solutions of Sandia LLC, a wholly owned subsidiary of Honeywell International Inc. for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-NA0003525.

What is the Pyroelectric Effect?

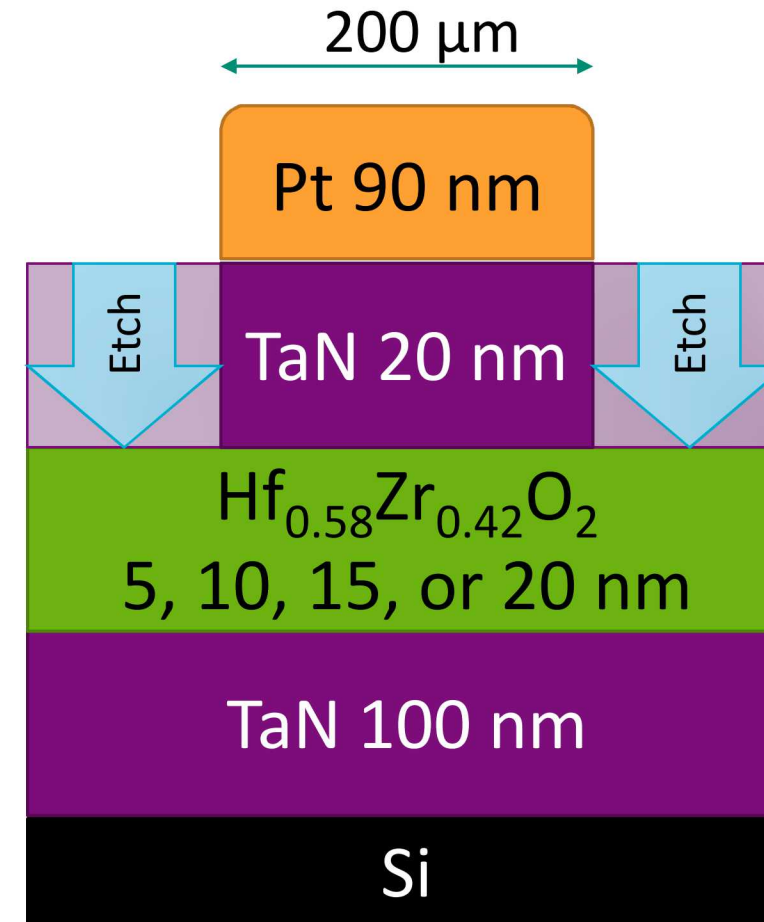


- All Ferroelectrics are also Pyroelectric
- Ferroelectric HfO_2 Thin Films
 - Potential for Night-Vision or Infrared Detector applications
 - Show consistent with other ferroelectrics
- If: spontaneous polarization
- Then: a uniform change in temperature creates a change in polarization
- Can be measured as a voltage or current

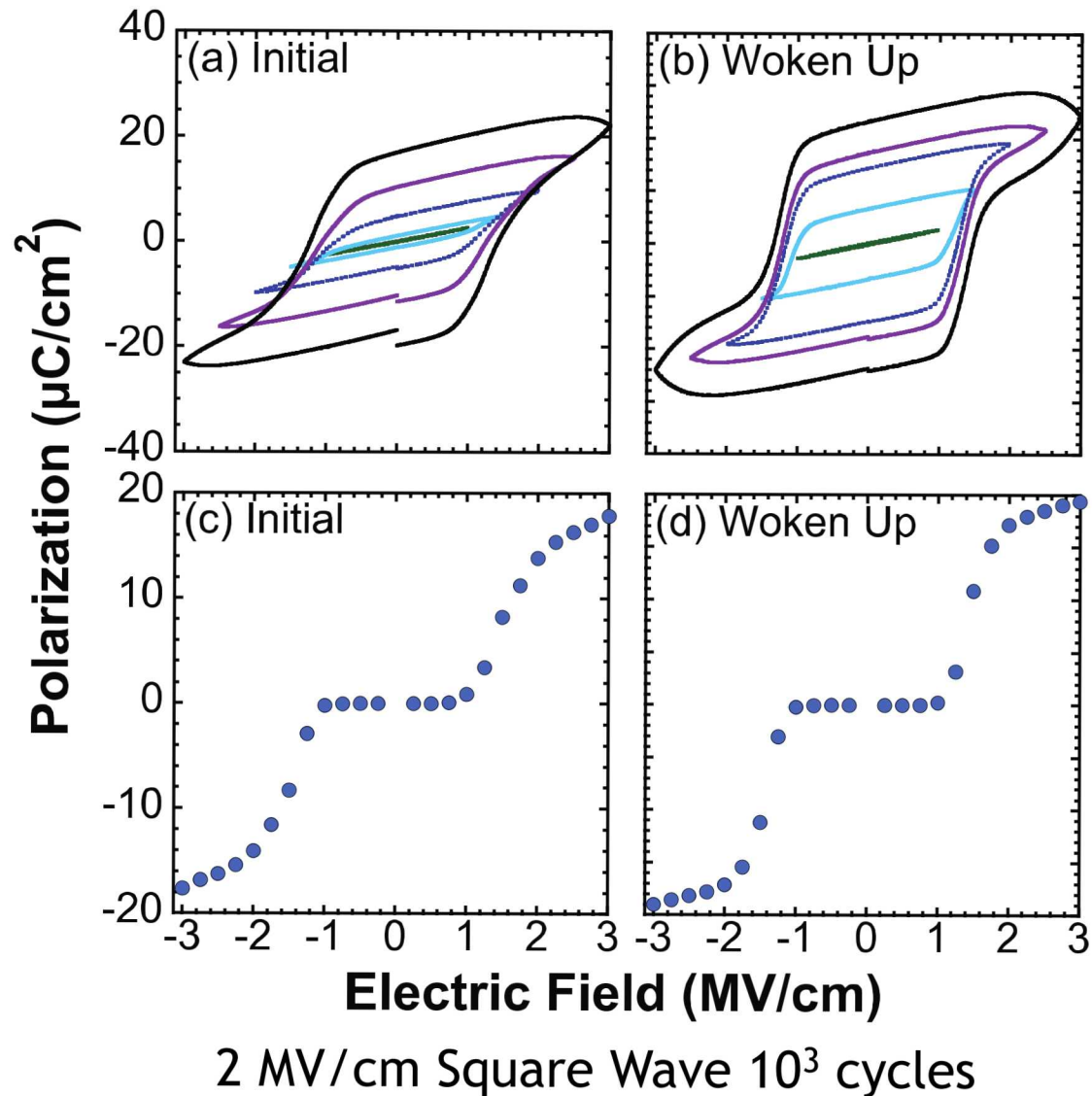


Experimental and Device Stack

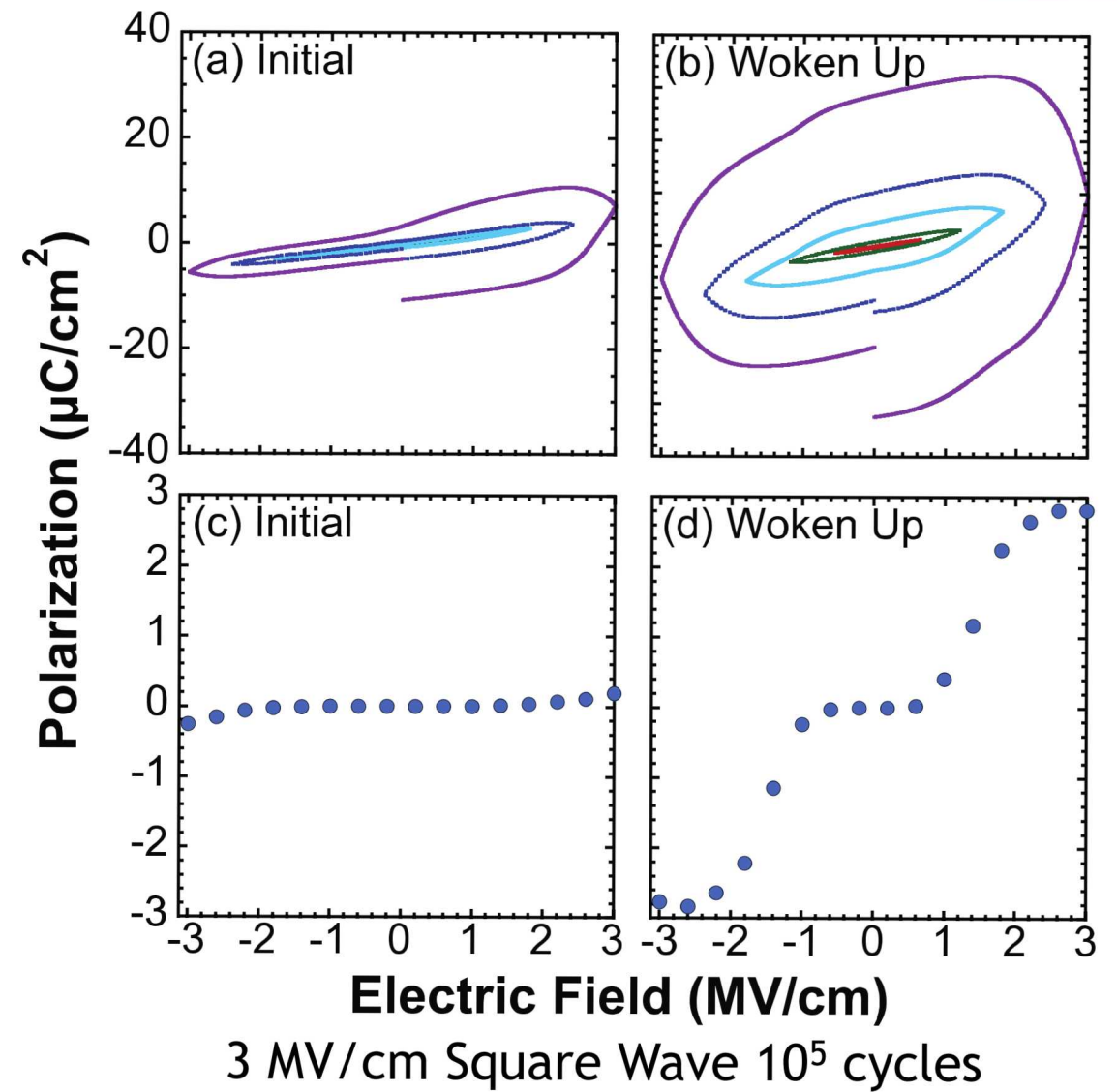
- RF sputter TaN from TaN target
- Thermal ALD $\text{Hf}_{0.58}\text{Zr}_{0.42}\text{O}_2$ at 150 °C by TDMA Hf, TDMA Zr, and H_2O
 - HfO_2 0.109 nm GPC
 - ZrO_2 0.097 nm GPC
 - 5 cycle ZrO_2 & 5 cycle HfO_2 supercycle (~1 nm)
- Rapid thermal anneal 30s at 600 °C under nitrogen
- Lithographically define sputtered Pt dots
- ICP reactive ion etch
 - SF_6 and C_4F_8 atmosphere

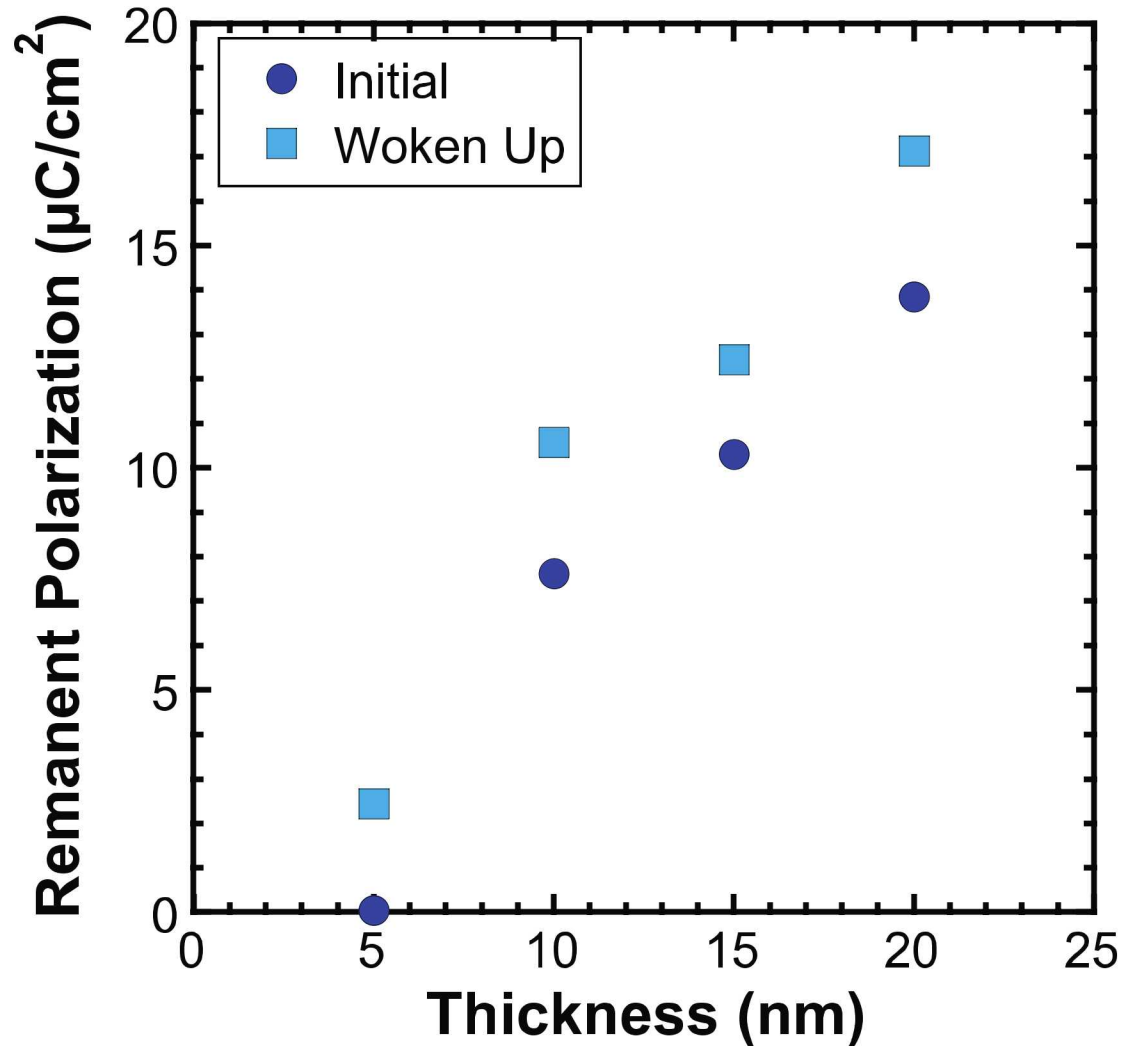


20 nm



5 nm





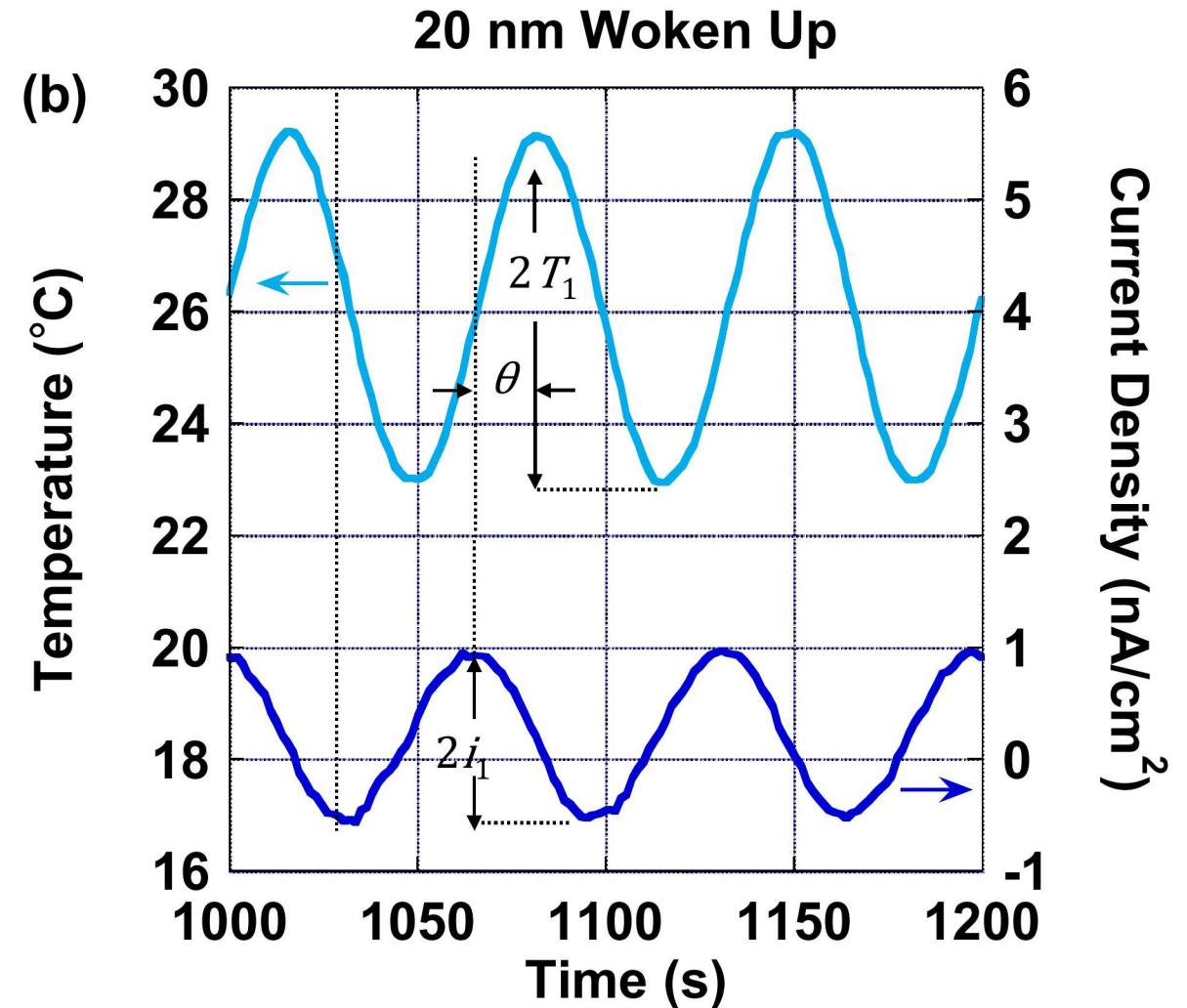
- Remanent polarization decreases with decreased thickness
- Wake up increases remanent polarization
 - Especially important in thin films

6 Pyroelectric Measurements

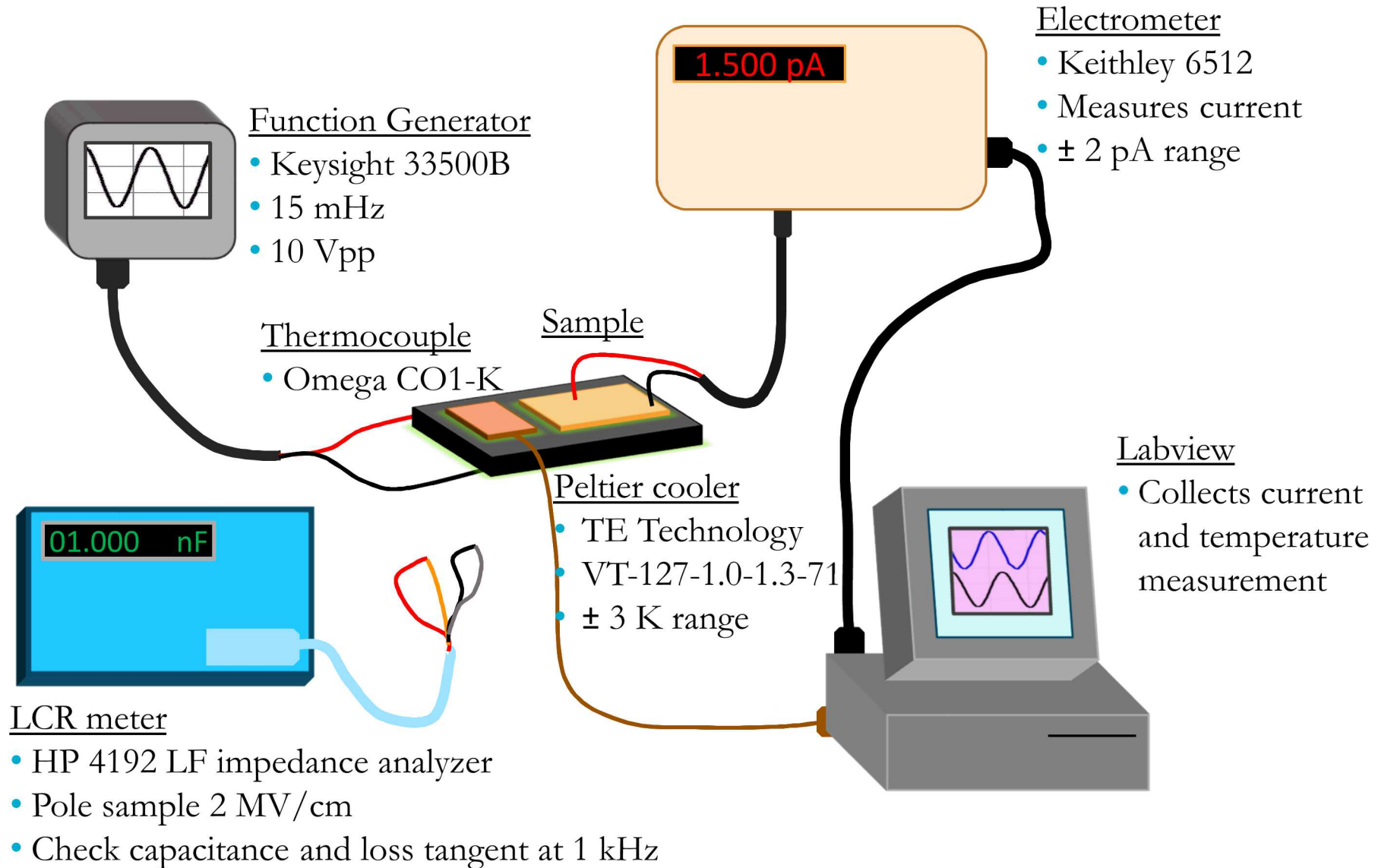
- Dynamic & Direct Measurement
 - Continuous change in temp and measure the current simultaneously
 - Sinusoidal Oscillating Temperature
 - Pyroelectric current depends on change in temperature with time
 - 90° out of phase

$$i_1 \sin(\theta) = pA\omega T_1$$

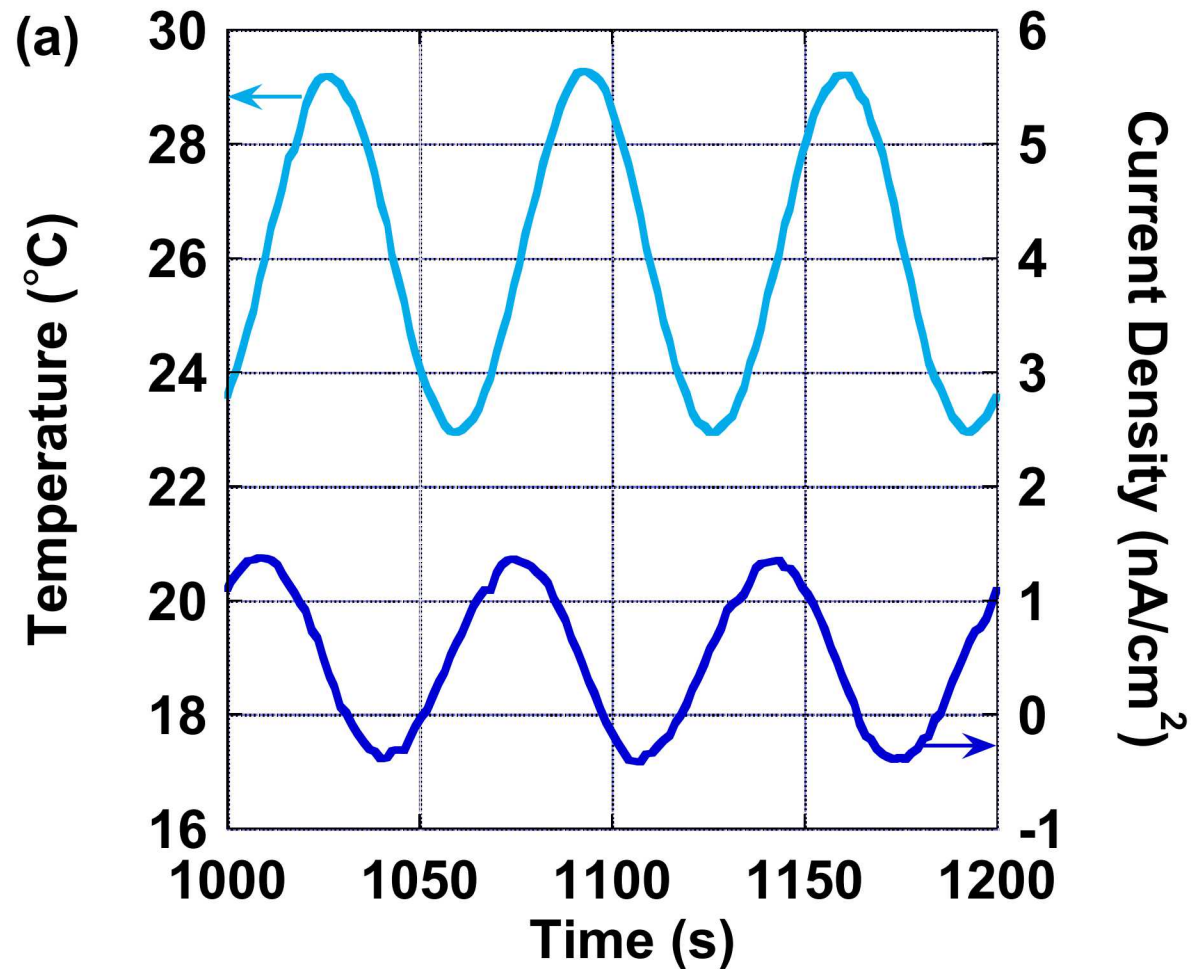
p – pyroelectric coefficient
 ω – angular frequency of temperature
 A – area of device



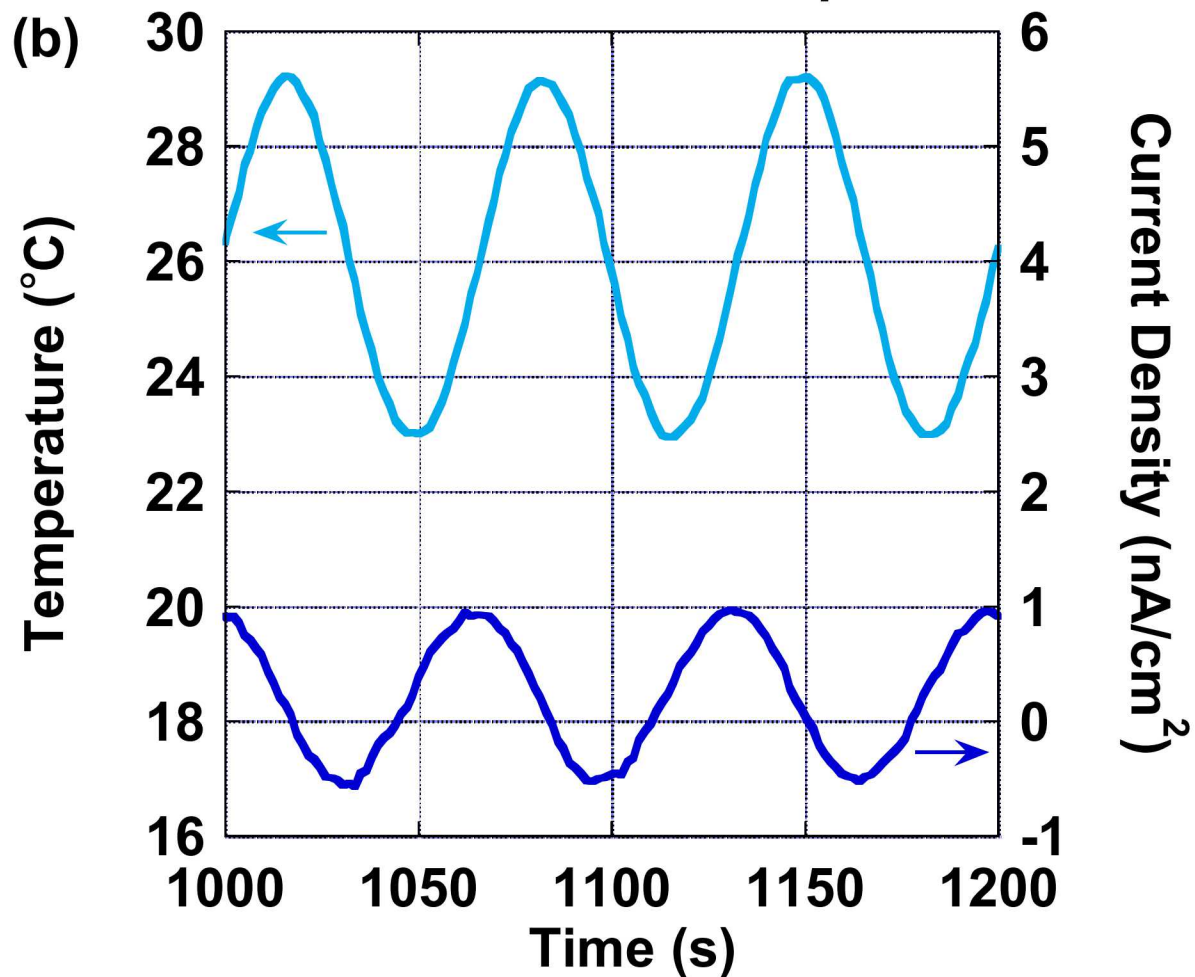
Pyroelectric Setup



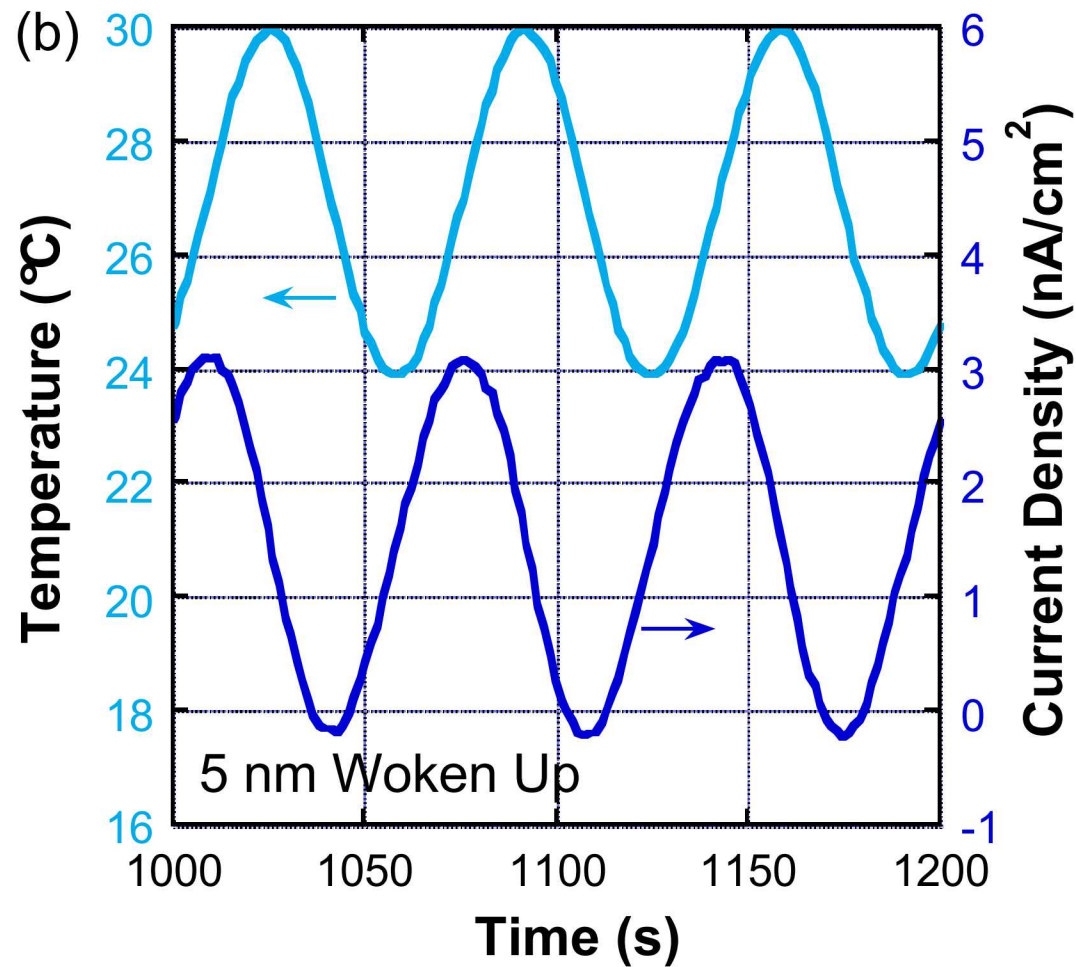
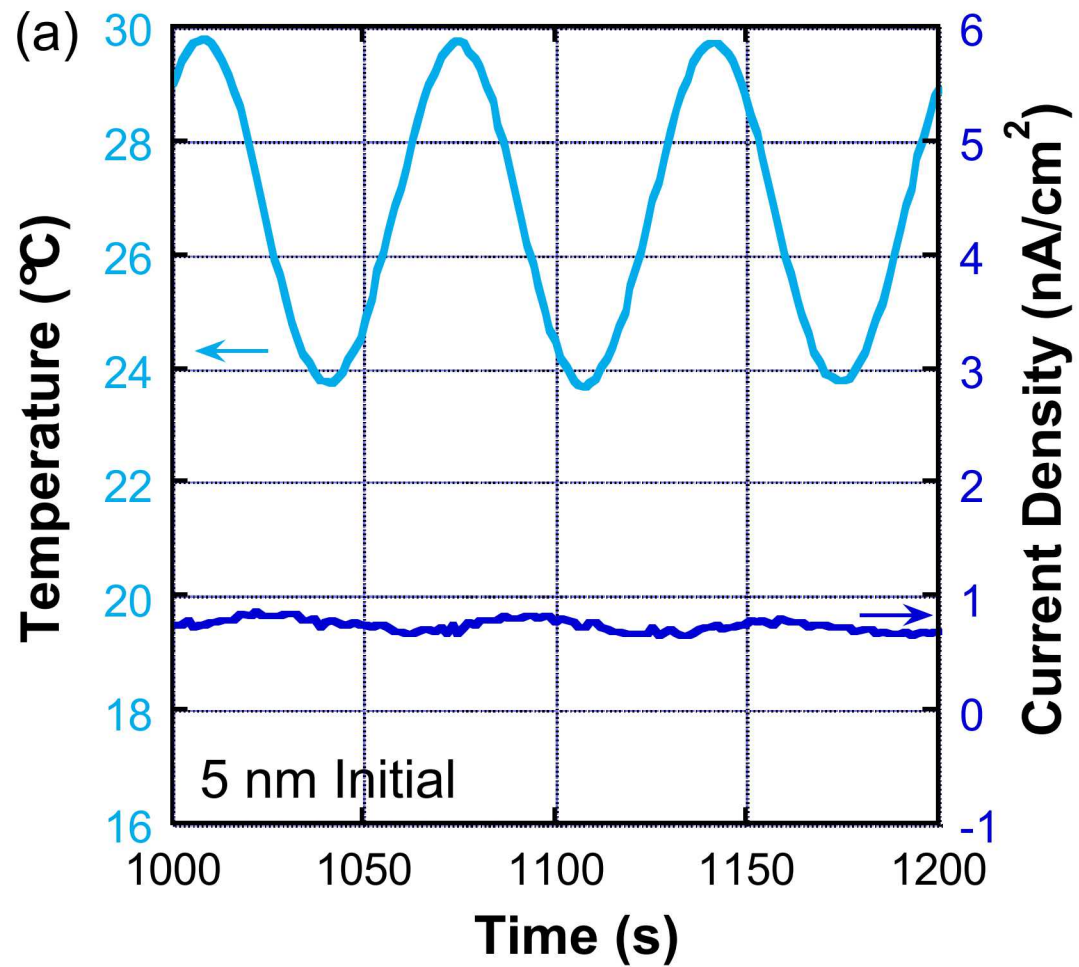
20 nm Initial



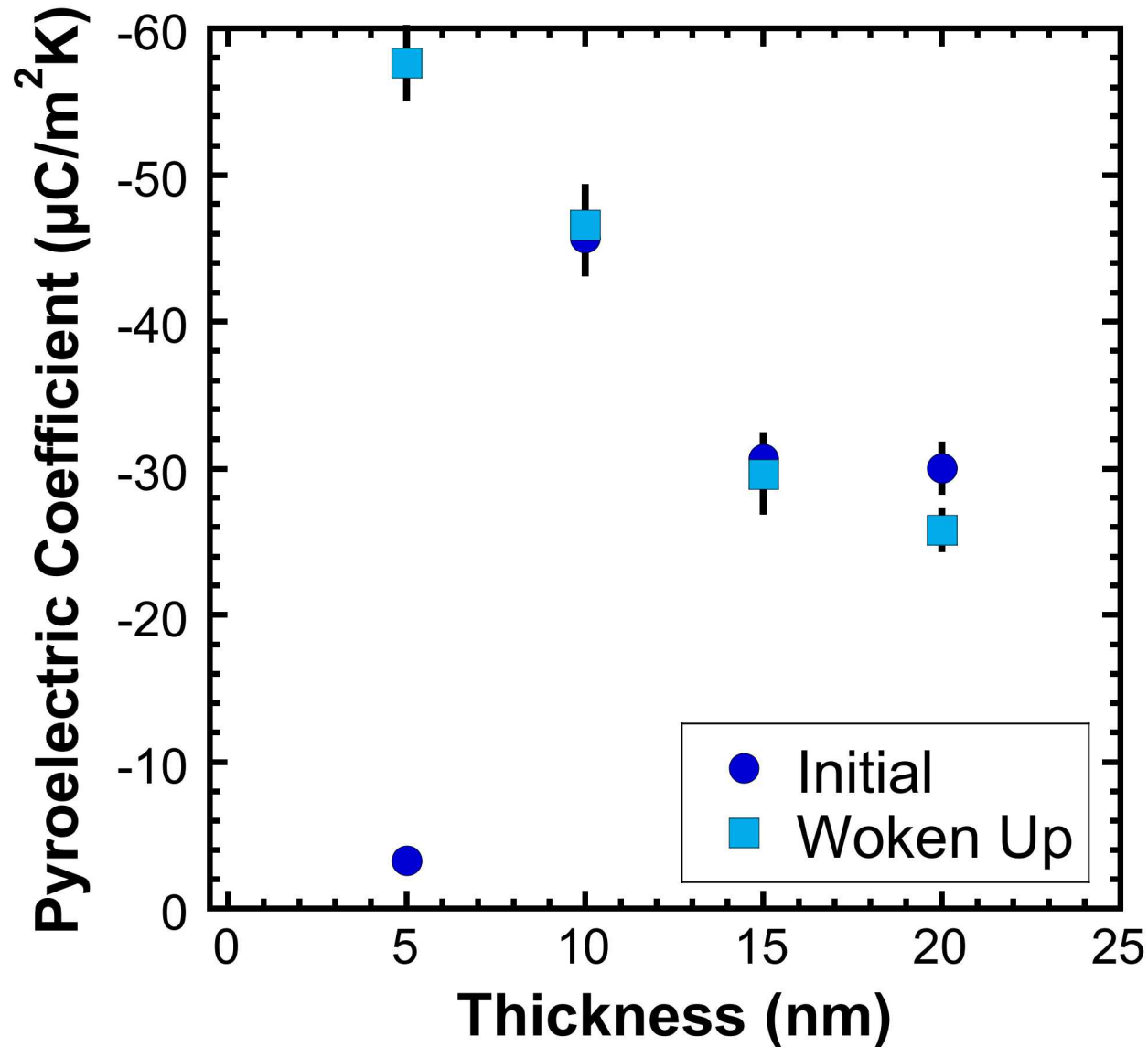
20 nm Woken Up



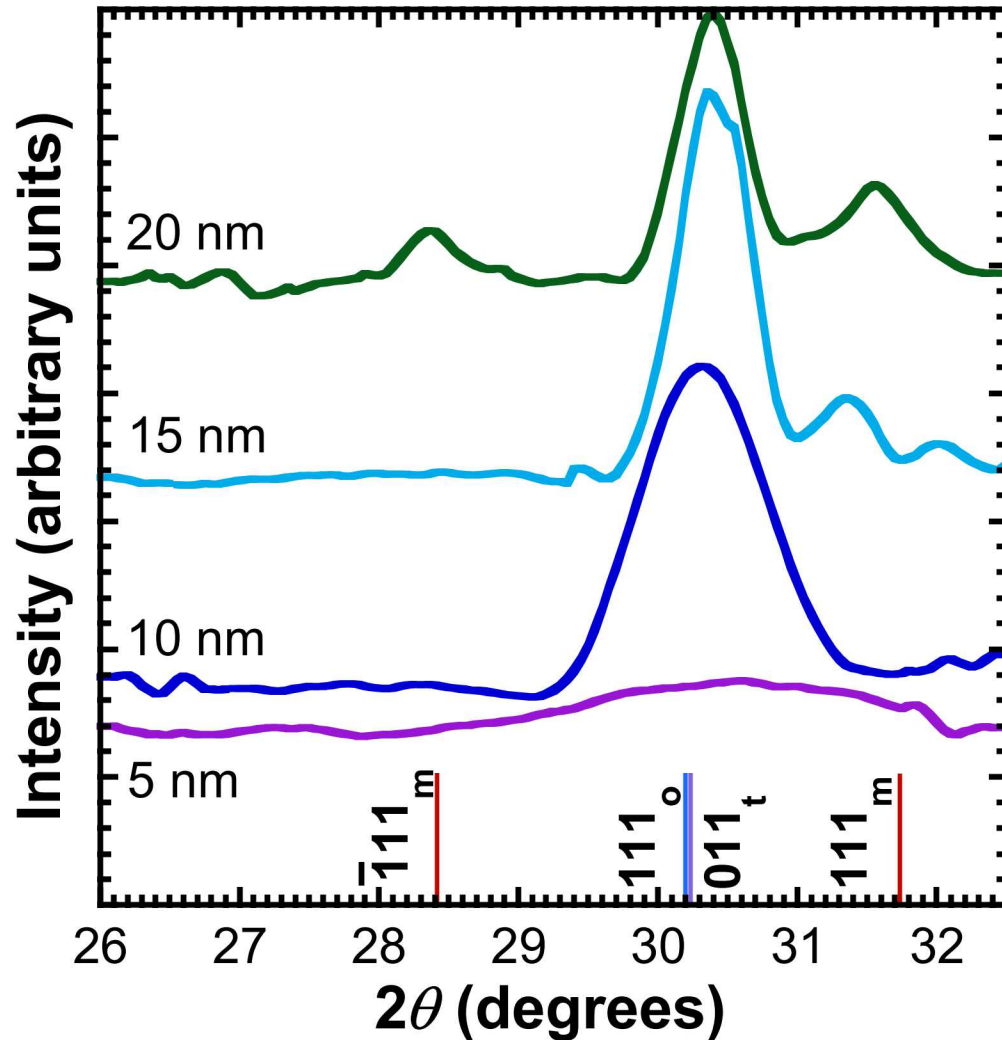
Pyroelectric Measurement 5 nm



Pyroelectric Coefficient with Thickness

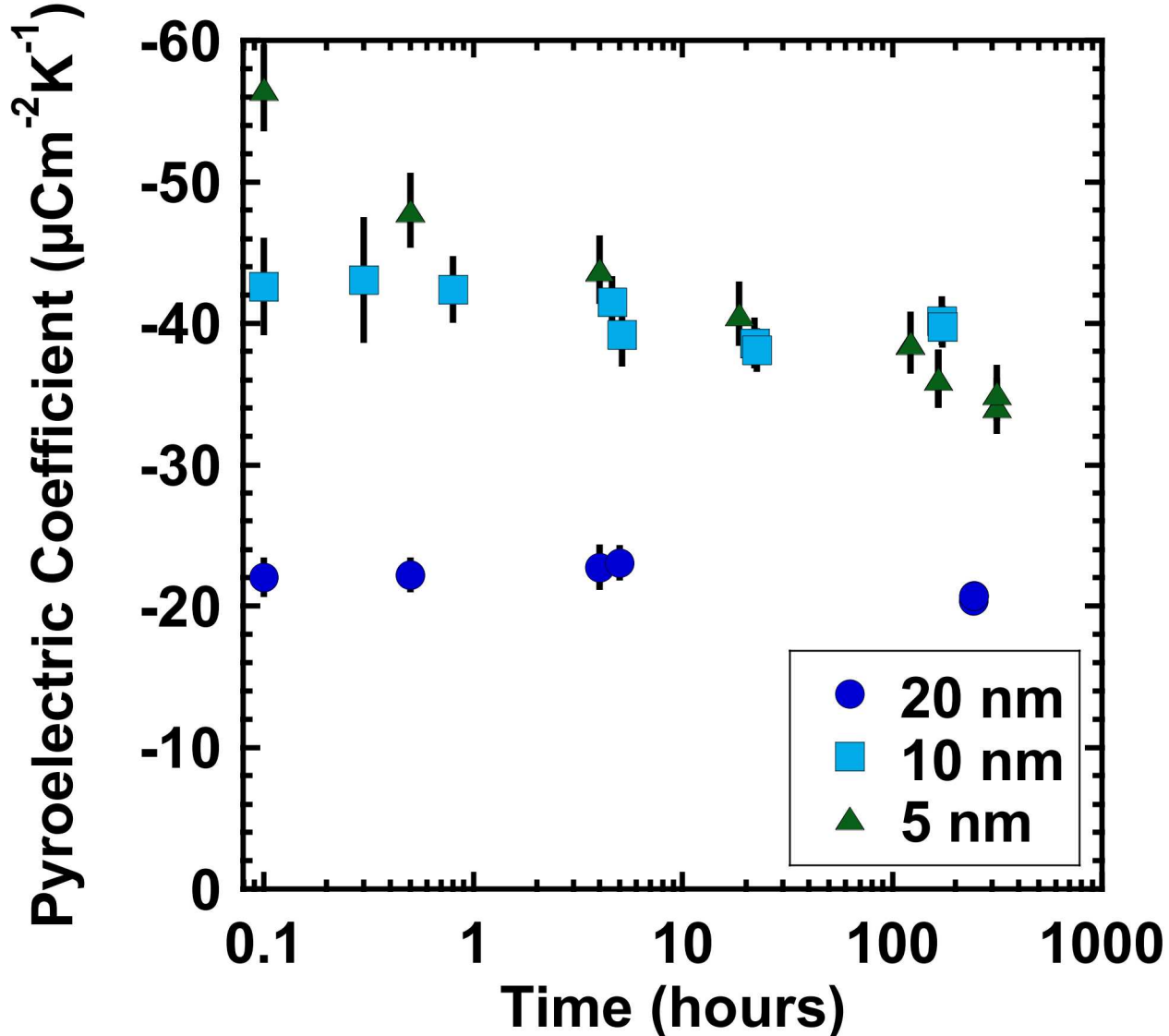


- Wake up makes little difference
 - Except 5 nm
- Pyroelectric coefficient increases as thickness decreases
- Increasing pyroelectric coefficient with decreasing polarization may indicate phase transition



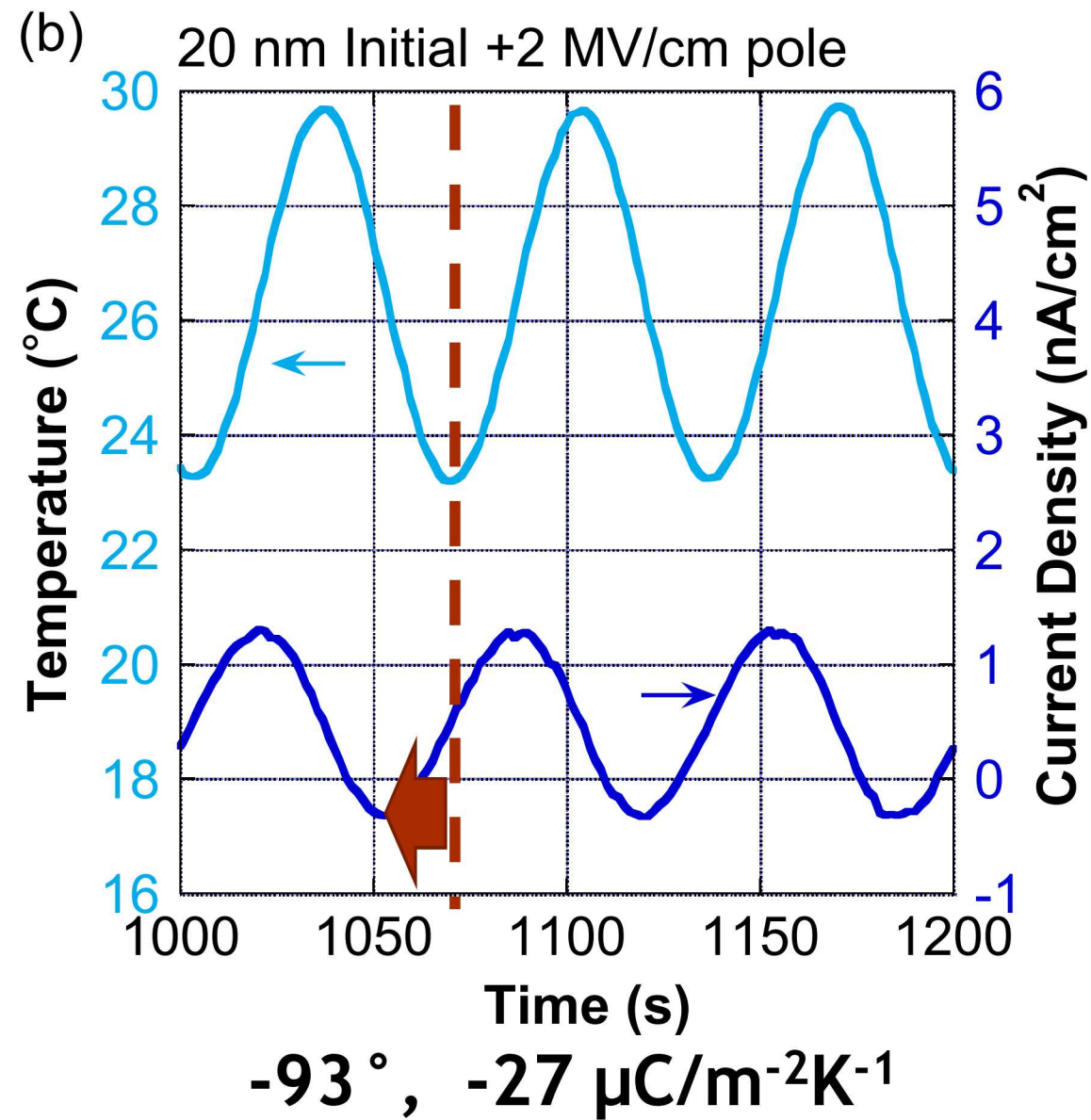
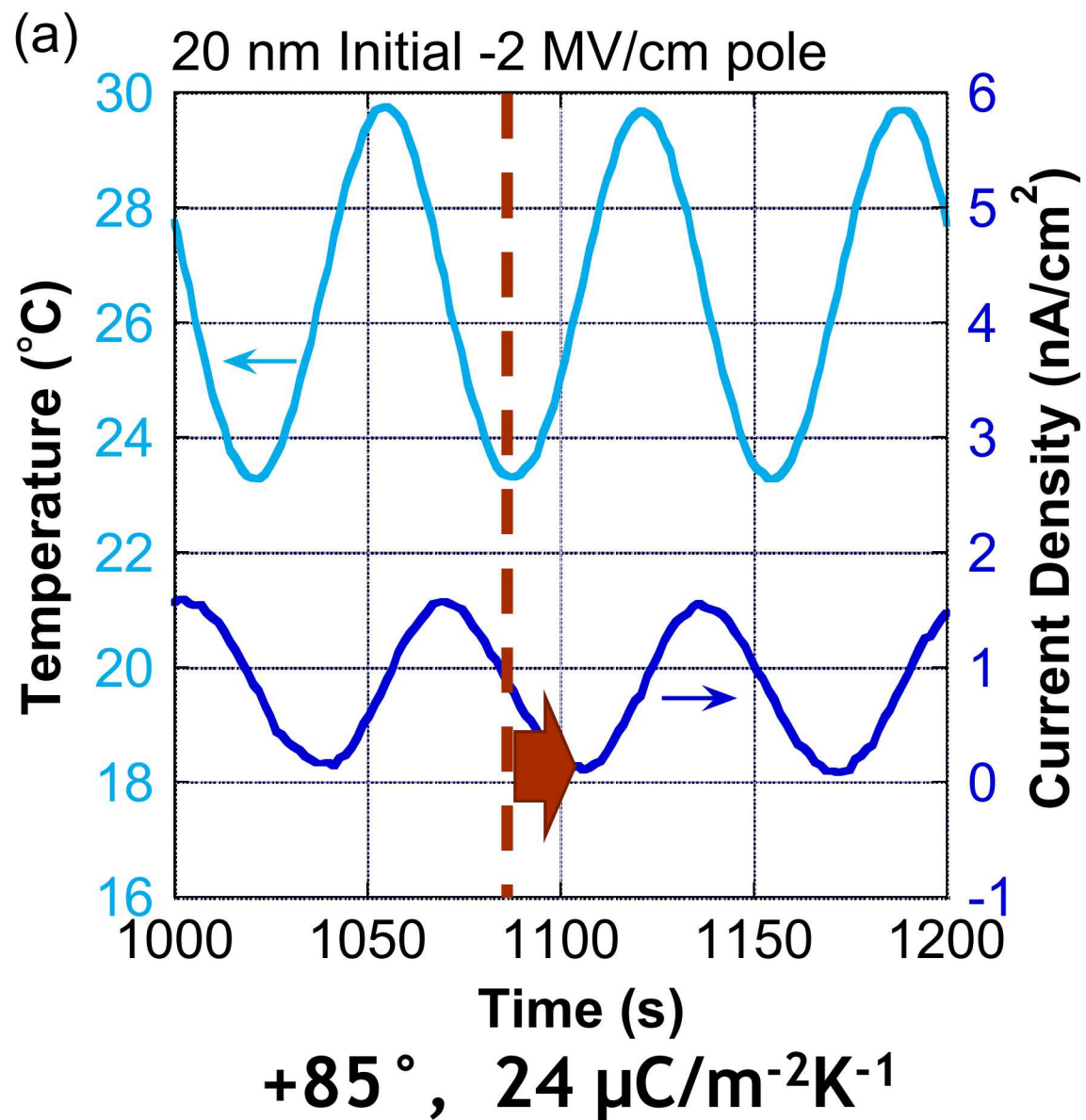
- Increasing Orthorhombic/tetragonal phase fraction with decreased thickness
 - 5 nm too broad to be conclusive
- Fitted grain sizes were consistent with film thickness
- Don't seem to be losing orthorhombic phase
 - Likely not phase change

Pyroelectric Coefficient Over Time

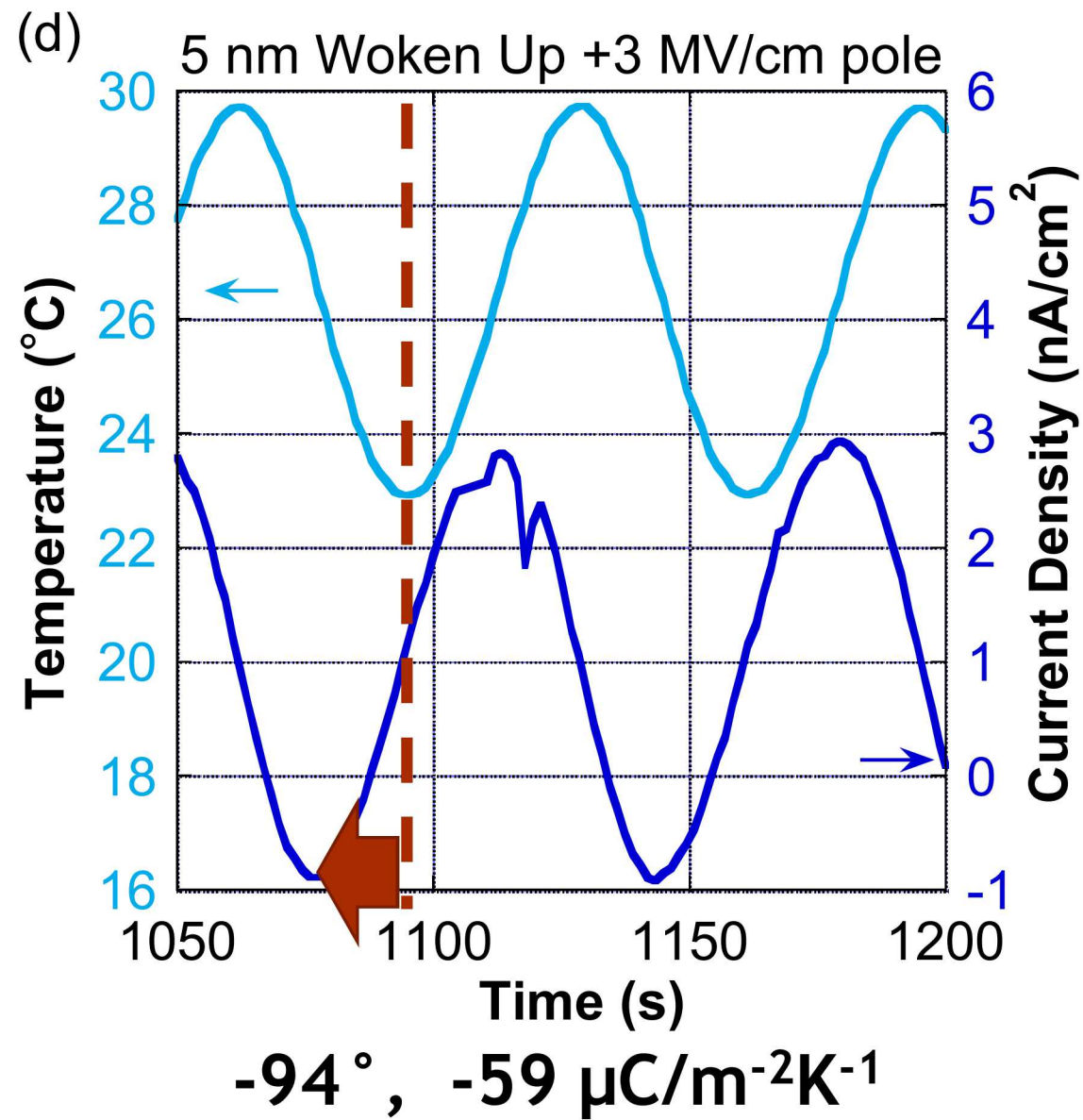
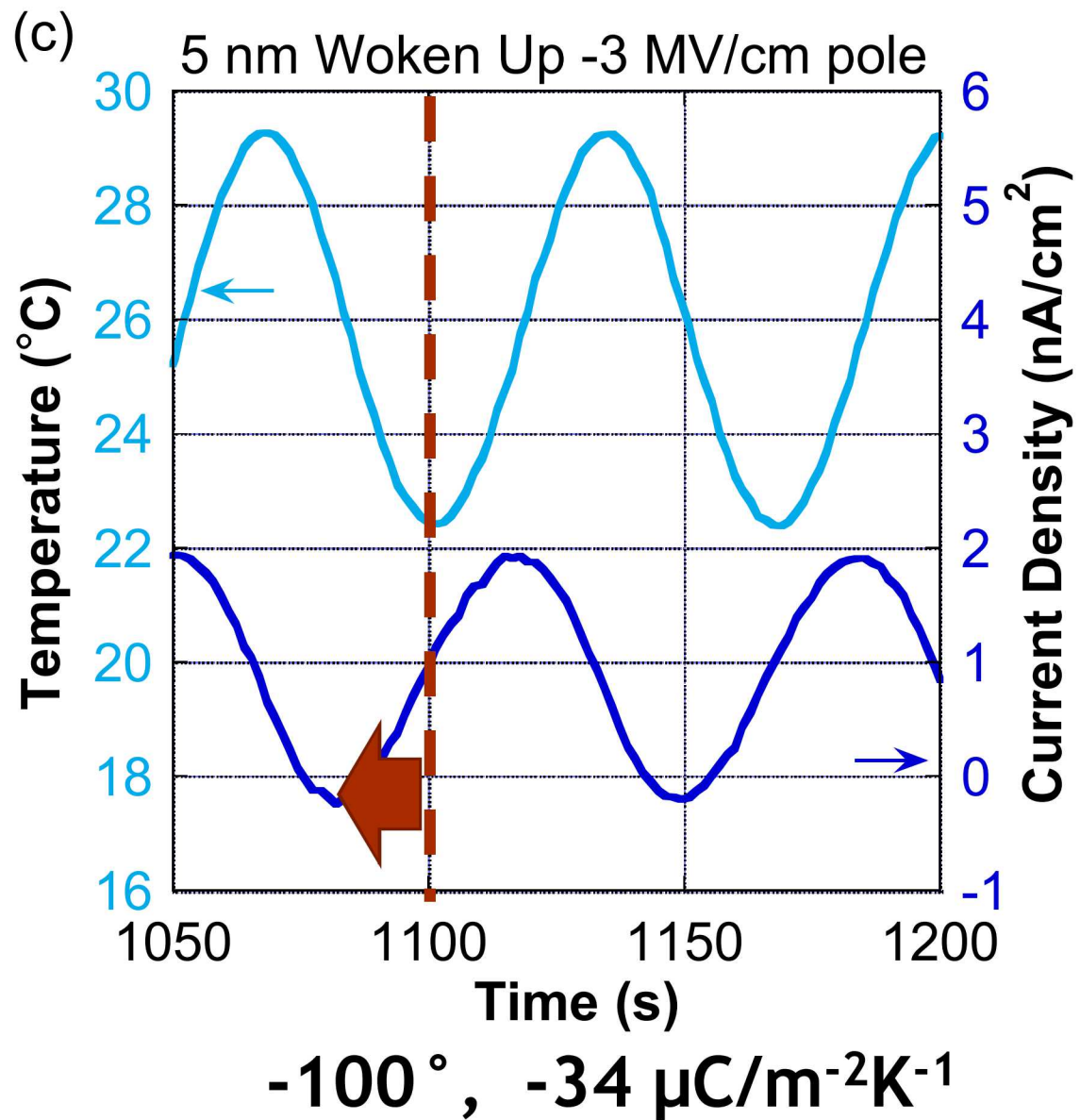


- 5 nm pyroelectric response decays
 - Not typical of ferroelectric
 - May be trapped charge contributing to response
- Similar decrease reported by Lane Martin's group in Berkeley with 10 nm Si:HfO₂, increased as a function of wake up.
 - S. Pandya et al., Physical Review Materials **2**, 124405 (2018)
- Decrease in polarization with time of 3 nm Y:HfO₂ with Ge bottom electrode mentioned, but not shown.
 - X. Tian et al., Appl. Phys. Lett. **112**, 102902 (2018)

Reversing Polarity on 20 nm Film

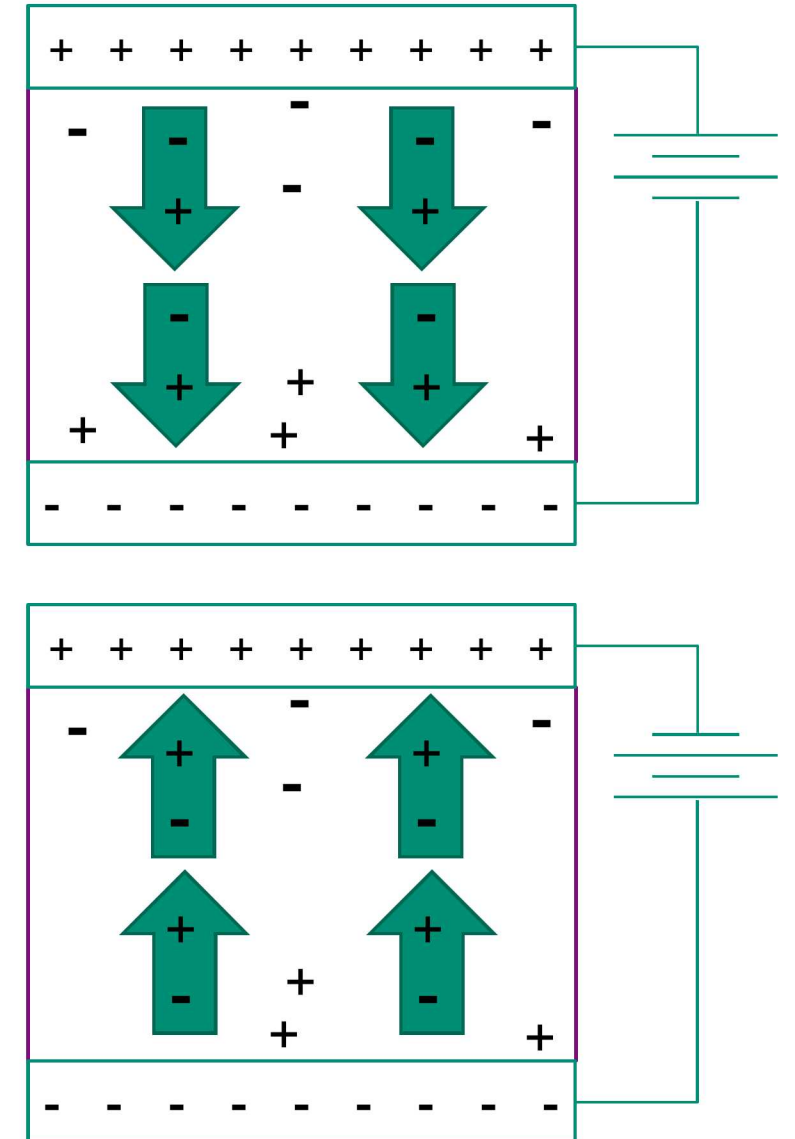


Reversing Polarity on a 5 nm Film



Thick (nm)	Negative Bias		Positive Bias		Delta Offset (°)
	Offset (°)	p ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	Offset (°)	p ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	
5	-100	-34	-94	-59	+6
10	+83	+31	-95	-42	-178
20	+85	+24	-93	-27	-178

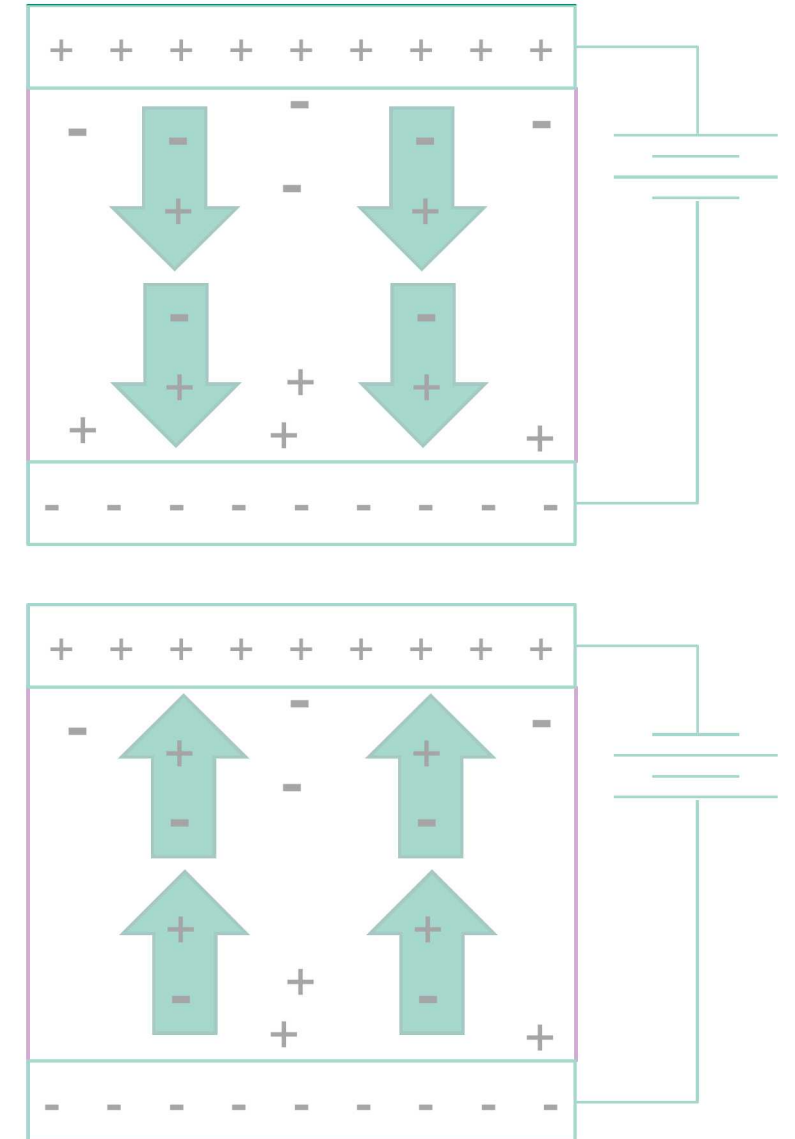
- Electret: point and/or dipole charge trapped in polymer or oxide
- Non-switchable charge contributing to the pyroelectric response
 - Likely injected during wake up cycling
 - Dominates switchable charge in 5 nm sample
 - Some present in 20 and 10 nm samples as well



Summary

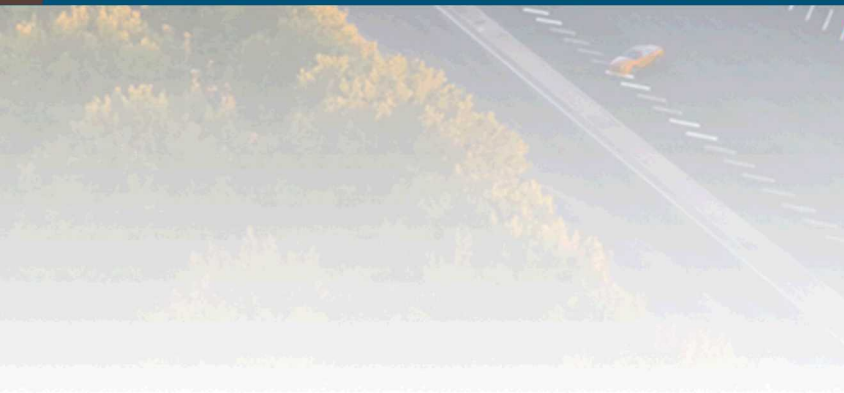
- Non switchable charge is contributing to the pyroelectric response in 5 nm $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$ films
 - Decays with time after poling
 - Not present prior to wake up
 - Present in 10 and 20 nm thick films as well but makes smaller contribution
- Unstable pyroelectric coefficient a problem for infrared detector applications
 - 10 nm $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$ seems OK
- May be dependent on the interface and wake up cycling

Thick (nm)	Negative Bias		Positive Bias		Delta Offset (°)
	Offset (°)	p ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	Offset (°)	p ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	
5	-100	-34	-94	-59	+6
10	+83	+31	-95	-42	-178
20	+85	+24	-93	-27	-178

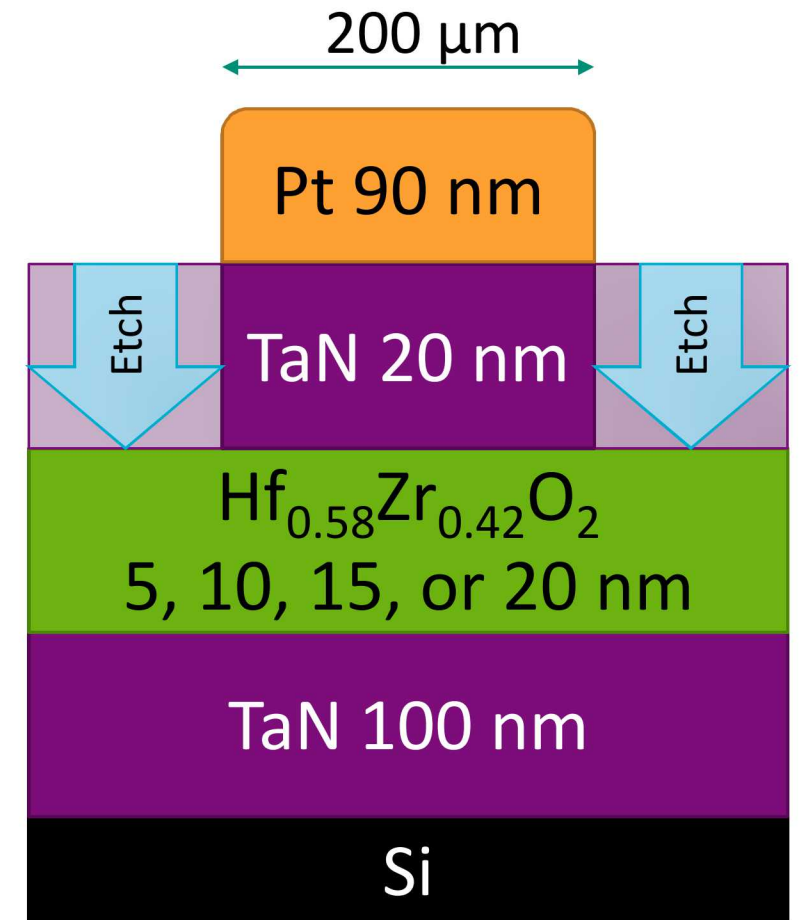




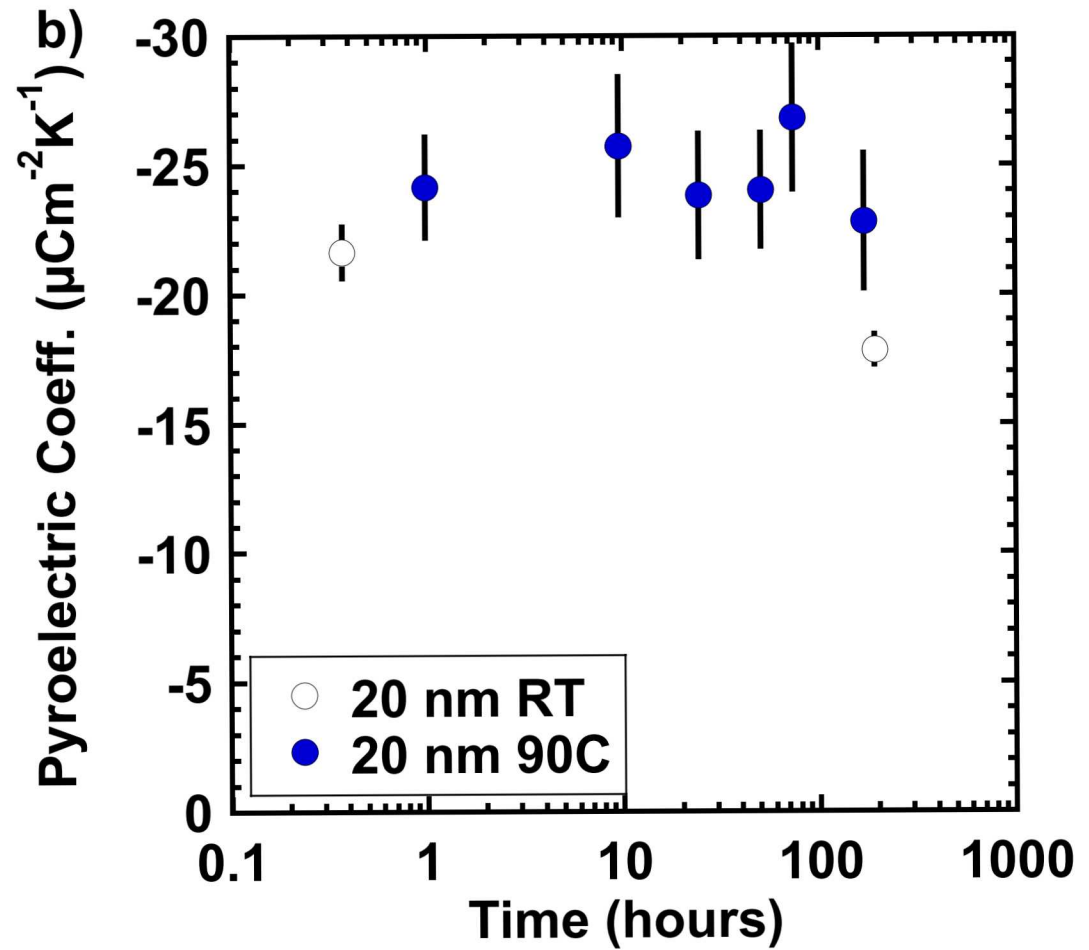
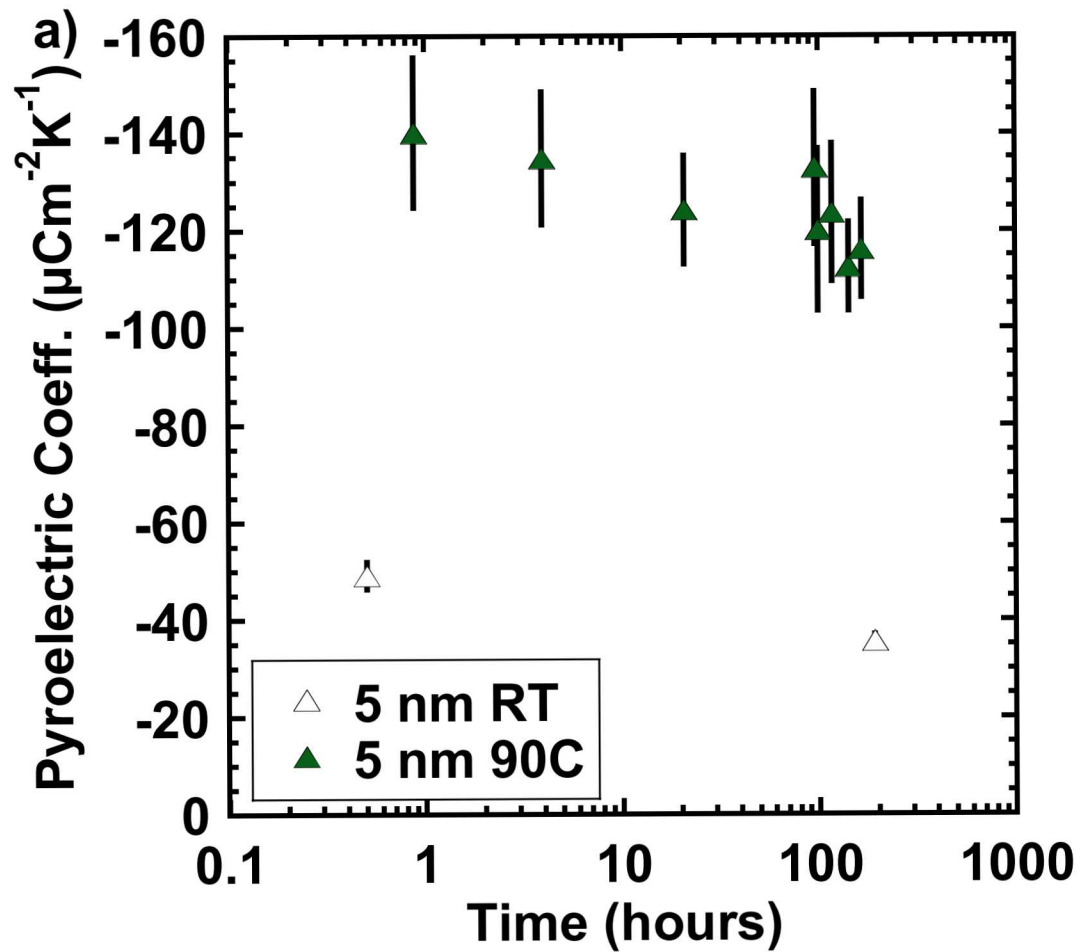
Backup Slides



Thick (nm)	Negative Bias		Positive Bias		Delta Offset (°)
	Offset (°)	ρ ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	Offset (°)	ρ ($\mu\text{C}/\text{m}^2\text{K}^{-1}$)	
5	+100	-34	+94	-59	+6
10	-83	+31	+95	-42	-178
20	-85	+24	+93	-27	-178



90 °C Pyroelectric Response Over Time

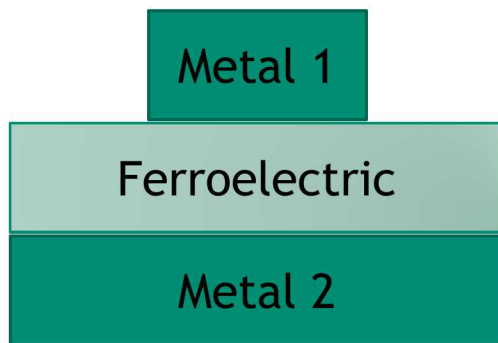


Ferroelectric Tunnel Junction

A switchable, permanent polarization enables switchable tunneling resistances*

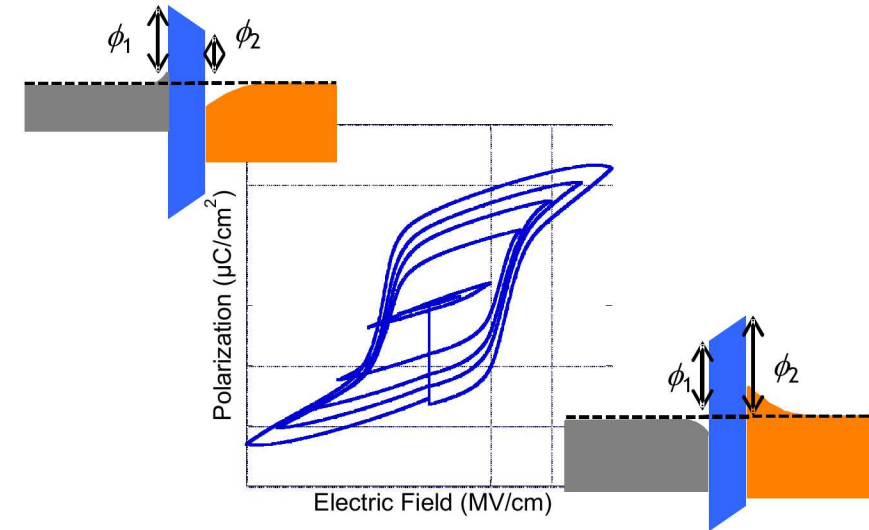
- Must be thin enough for tunneling (<5nm)

Recently discovered ferroelectric HfO_2 offers low cost, Si compatible option

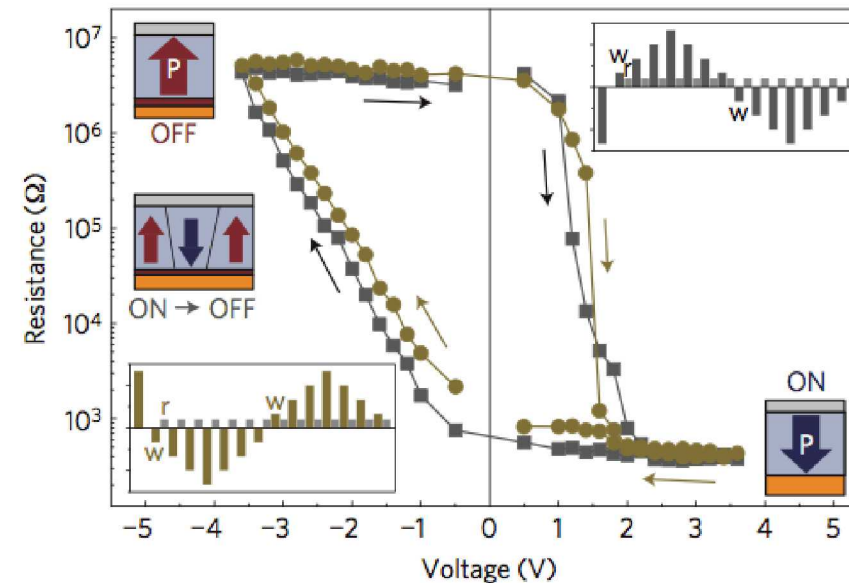


*Kohlstedt, et al. Phys. Rev. B **72**, 125341 (2005)

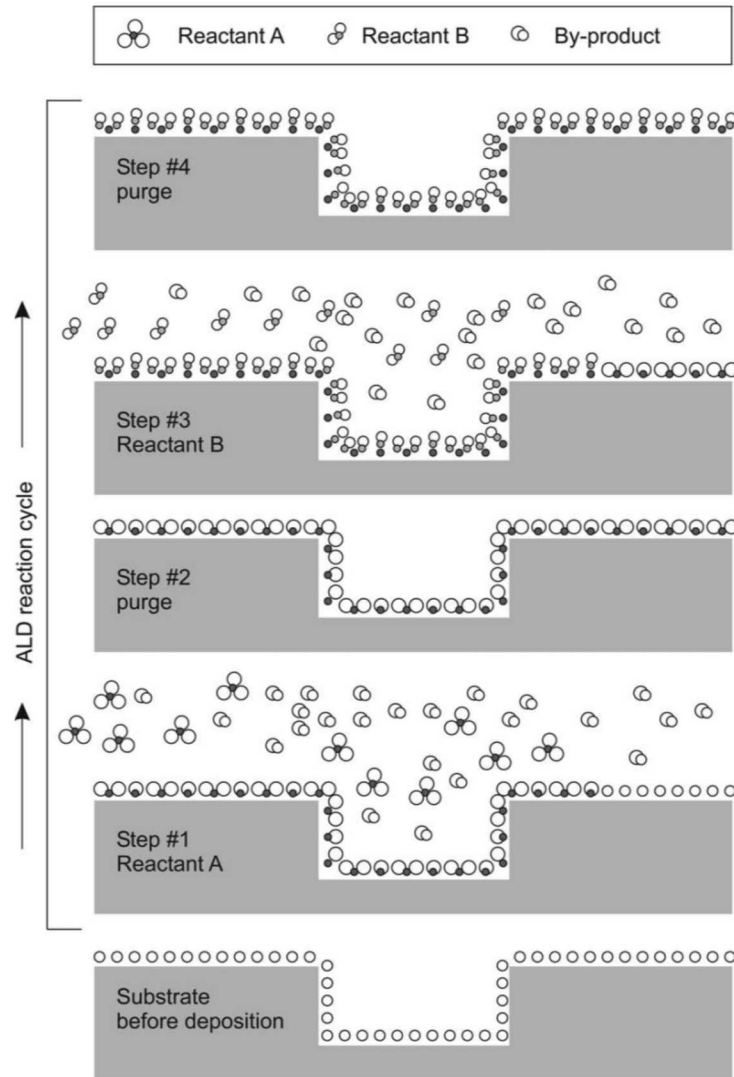
Wen *et al.*, Nat. Mater. 12, 617 (2013)



Pt/BaTiO₃/Nb:SrTiO₃



3 Atomic Layer Deposition



Schematic of ALD process

Variant of Chemical Vapor Deposition

Reactants separated by inert gas purge

Reaction limited to chemisorbed surface layer

Conformal over high aspect ratios

Precise thickness control with sub-monolayer growth per cycle

Multicomponent and graded compositions

Ferroelectric HfO₂

2011 Boscke *et al.* – Namlab

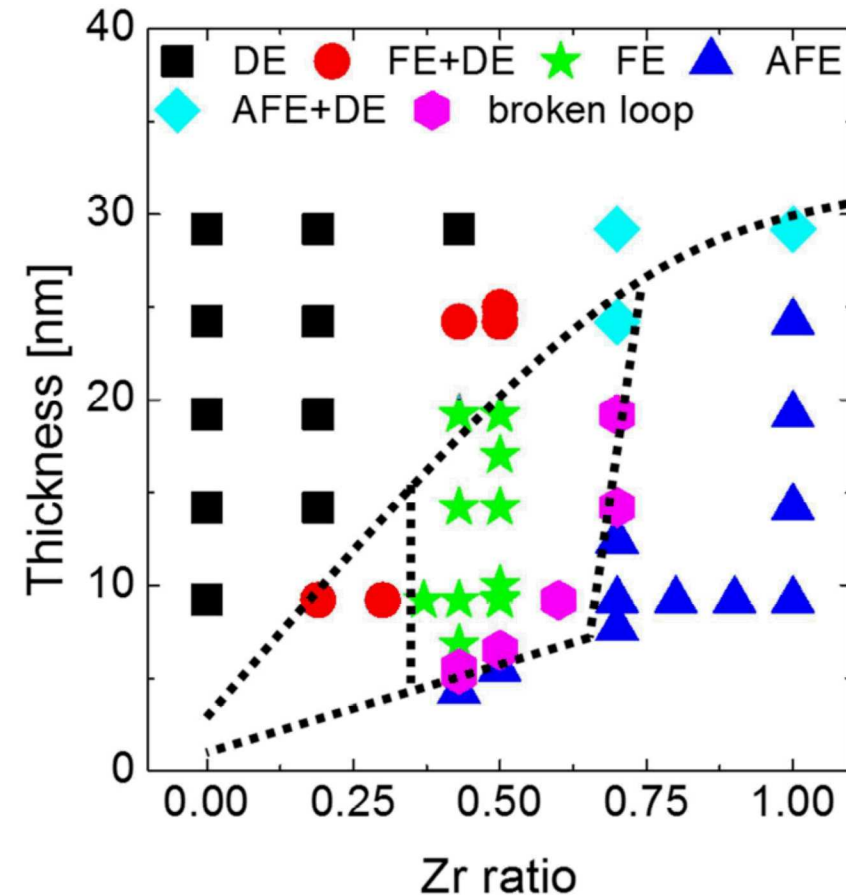
- 2 to 5% Si:HfO₂ via ALD with TiN top and bottom electrodes and anneal.
- Proposed metastable orthorhombic crystal structure.

Since then:

- Dopants: Zr, Gd, Al, none,...
- Electrodes: Mostly TiN, TaN, Pt, Ir, Ru Si, ...
- Thickness: 25 to ~5 nm, maybe less

CMOS compatible ferroelectric stable at <20 nm thickness.

- Applications: ferroelectric memory, energy storage & harvesting, low power FETs.

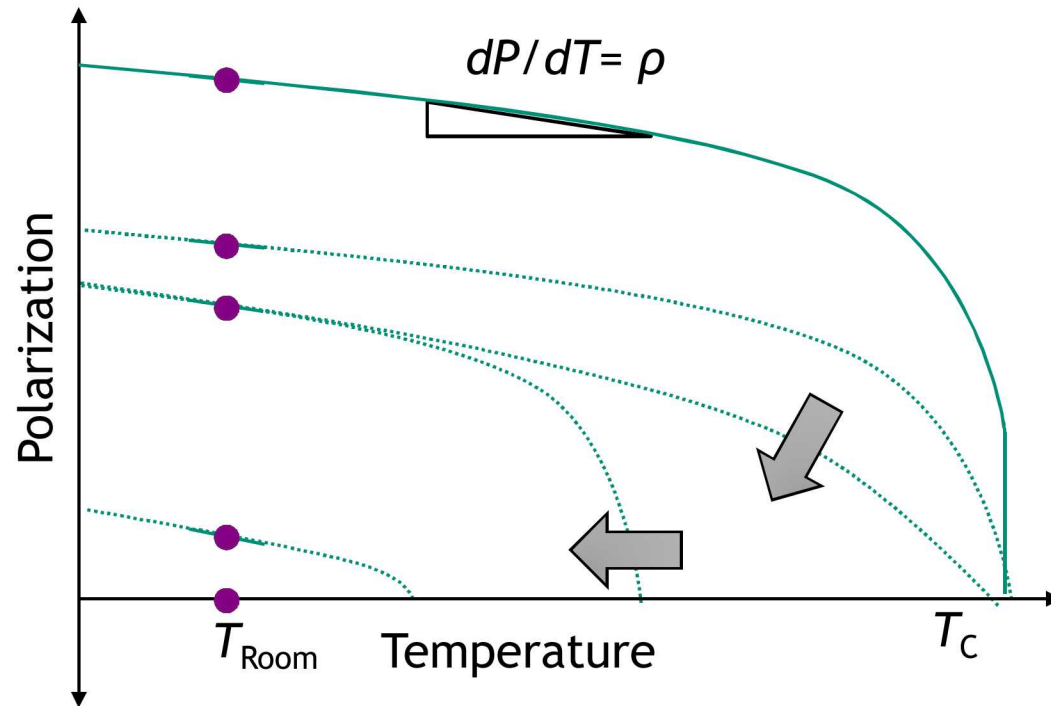


DE-dielectric
FE-ferroelectric
AFE-antiferroelectric-like

Böscke, *et al.*, *Appl. Phys. Lett.* **99**, 102903 (2011)

M.H. Park, *et al.*, *Nanoscale*, June 2017 DOI:10.1039/C7NR02121F

Pyroelectric Coefficient with Thickness



As thickness decreases:

- Polarization decreases
- Pyroelectric coefficient increases

Polarization vs. temperature curve response:

- Phase transition becomes more gradual
- T_C decreases

What is a Ferroelectric Material?

Spontaneous polarization which can be reoriented by an electric field

Noncentrosymmetric ionic crystals

- Centers of positive and negative charge do not coincide

Applications

- Memory: FRAM
- Actuators: Ultrasound, Sonar, AFMs
- Capacitors: Cellphones and nearly all electronics
- Sensors: Night vision, IR cameras
 - Due to pyroelectric effect

